Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	80mΩ@10V	10A
	85mΩ@4.5V	
-100V	85mΩ@-10V	-15A
	95mΩ@-4.5V	

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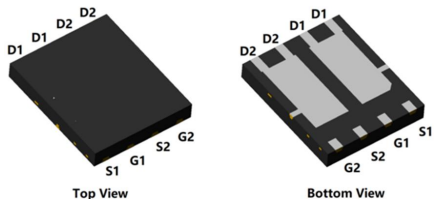
Feature

- Fast switching speed
- Surface mount package
- ROHS Compliant & Halogen-Free
- 100% Single Pulse avalanche energy Test

Applications

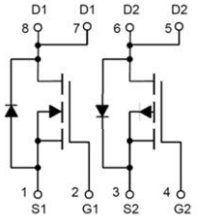
- DC-DC Converters.
- Motor Control.

Package



PDFN5X6-8L

Circuit diagram



Marking

SP1011CNK :Device Code
** :Week Code

Order Information

Device	Package	Unit/Tape
SP1011CNK	PDFN5X6-8L	5000

Absolute maximum ratings (Ta=25℃,unless otherwise noted)

Parameter	Symbol	Rating		Unit
		N-Channel	P-Channel	
Drain-Source Voltage	V_{DS}	100	-100	V
Gate-Source Voltage	V_{GS}	±20	±20	V
Continuous Drain Current (Tc=25°C)	I_D	10	-15	A
Pulse Drain Current Tested	I_{DM}	40	-60	A
Single pulsed avalanche energy[1]	E_{AS}	25	156	mJ
Power Dissipation (Tc=25°C)	P_D	45		W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.8		°C/W
Storage Temperature Range	T_{STG}	-55 to 150		°C
Operating Junction Temperature Range	T_J	-55 to 150		°C

N-Electrical characteristics (Ta=25℃, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	VGS=0V , ID=250uA	100	-	-	V
Drain-Source Leakage Current	I_{DSS}	VDS=80V , VGS=0V , TJ=25℃	-	-	1	uA
Gate-Source Leakage Current	I_{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	VGS=VDS , ID =250uA	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	VGS = 10V, ID = 8A	-	80	100	mΩ
		VGS = 4.5V, ID = 6A	-	85	115	
Dynamic characteristics						
Input Capacitance	C_{iss}	VDS=50V , VGS=0V , f=1MHz	-	951	-	pF
Output Capacitance	C_{oss}		-	32.3	-	
Reverse Transfer Capacitance	C_{rss}		-	27.3	-	
Total Gate Charge	Q_g	VDS=50V , VGS=10V , ID=6A	-	20.2	-	nC
Gate-Source Charge	Q_{gs}		-	2.1	-	
Gate-Drain Charge	Q_{gd}		-	4.2	-	
Switching Characteristics						
Turn-On Delay Time	$T_{d(on)}$	VDD=50V VGS=10V , RG=3Ω, ID=6A	-	6.6	-	nS
Rise Time	T_r		-	46	-	
Turn-Off Delay Time	$T_{d(off)}$		-	31	-	
Fall Time	T_f		-	4	-	
Diode Characteristics						
Diode Forward Voltage	V_{SD}	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Maximum Body-Diode Continuous Current	I_S		-	-	10	A
Reverse recover time	T_{rr}	IS=6A, di/dt=100A/us, Tj=25℃	-	31	-	nS
Reverse recovery charge	Q_{rr}		-	23	-	nC

Note：

1.The EAS Test condition is VDD=50V,VGS =10V,L = 0.5mH, Rg=25Ω

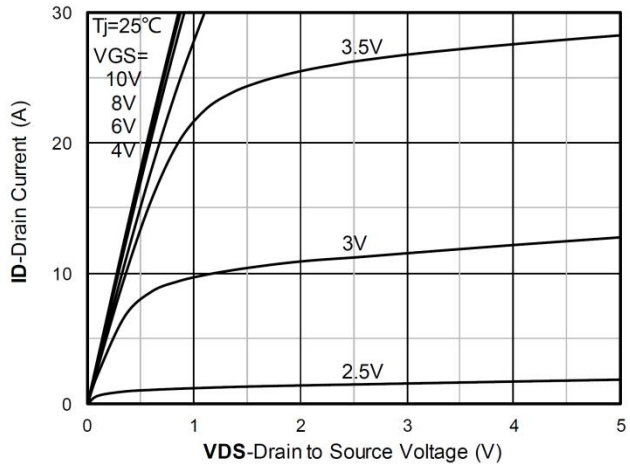
P-Electrical characteristics (Ta=25℃, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	VGS=0V , ID=-250uA	-100	-	-	V
Drain-Source Leakage Current	I_{DSS}	VDS=-80V , VGS=0V , TJ=25℃	-	-	-1	uA
Gate-Source Leakage Current	I_{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	VGS=VDS , ID =-250uA	-1.0	-1.8	-2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	VGS =-10V, ID =-8A	-	85	105	mΩ
		VGS =-4.5V, ID =-6A	-	95	125	
Dynamic characteristics						
Input Capacitance	C_{iss}	VDS=-50V , VGS=0V , f=1MHz	-	3769	-	pF
Output Capacitance	C_{oss}		-	72.3	-	
Reverse Transfer Capacitance	C_{rss}		-	66.4	-	
Total Gate Charge	Q_g	VDS=-50V , VGS=-10V , ID=-6A	-	72	-	nC
Gate-Source Charge	Q_{gs}		-	8.4	-	
Gate-Drain Charge	Q_{gd}		-	17.3	-	
Switching Characteristics						
Turn-On Delay Time	$T_{d(on)}$	VDD=-50V VGS=-10V , RG=6Ω, ID=-5A	-	11.6	-	nS
Rise Time	T_r		-	17.6	-	
Turn-Off Delay Time	$T_{d(off)}$		-	115.2	-	
Fall Time	T_f		-	42	-	
Diode Characteristics						
Diode Forward Voltage	V_{SD}	VGS=0V , IS=-1A , TJ=25℃	-	-	-1.2	V
Maximum Body-Diode Continuous Current	I_S		-	-	-15	A
Reverse recover time	T_{rr}	I_S=-5A, di/dt=-100A/us, Tj=25℃	-	79	-	nS
Reverse recovery charge	Q_{rr}		-	141	-	nC

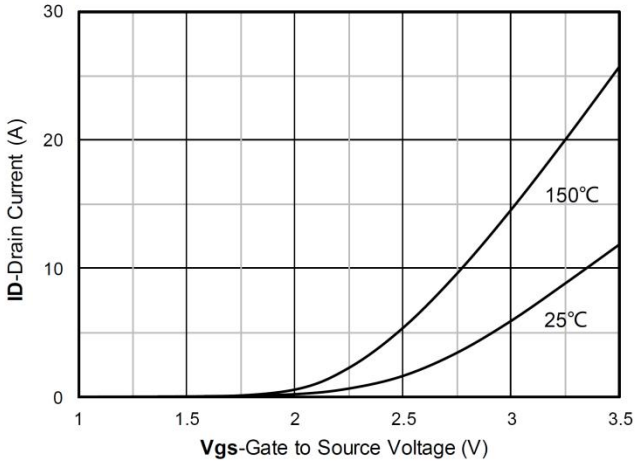
Note：

1.The EAS Test condition is VDD=-50V,VGS =-10V,L = 0.5mH, Rg=25Ω

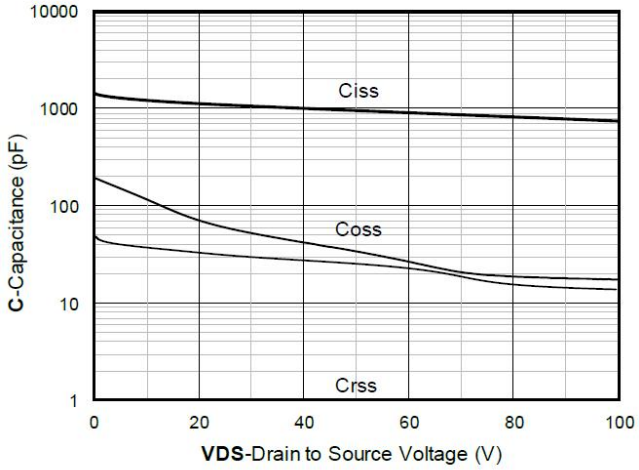
N-Channel Typical Characteristics



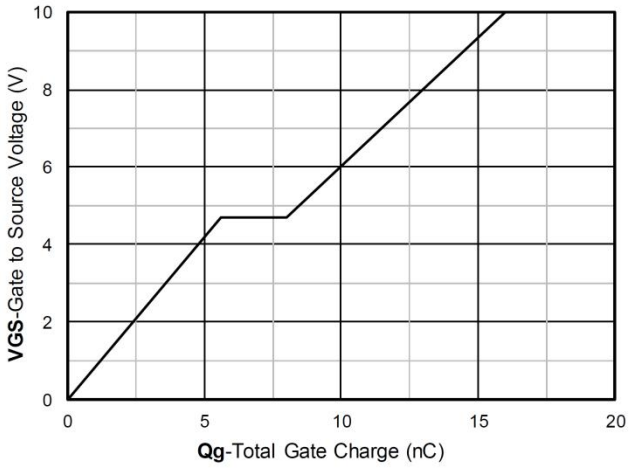
Output Characteristics



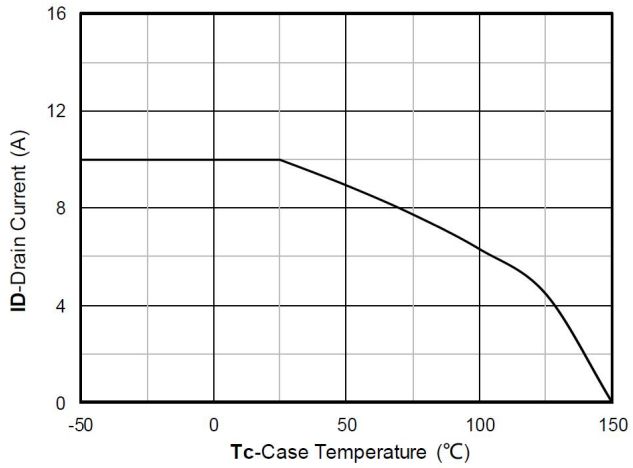
Transfer Characteristics



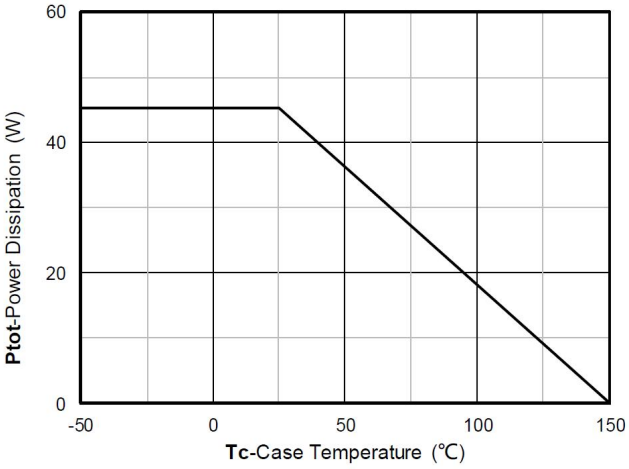
Capacitance Characteristics



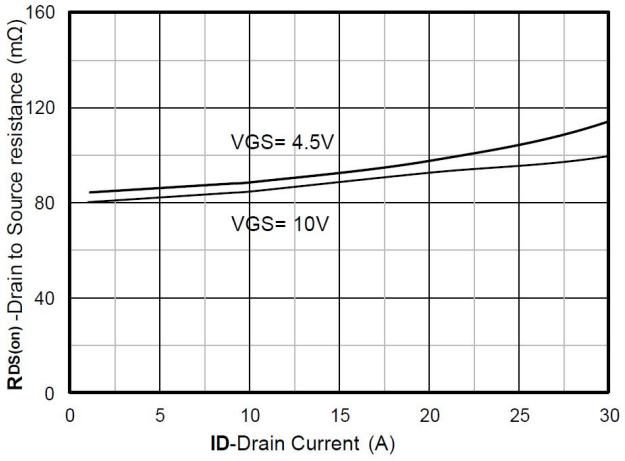
Gate Charge



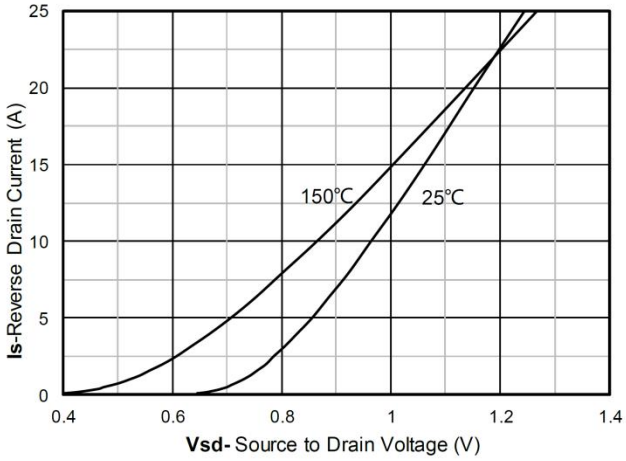
Current dissipation



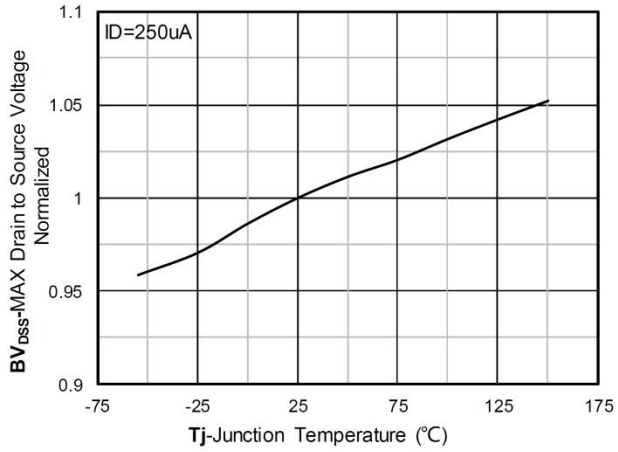
Power dissipation



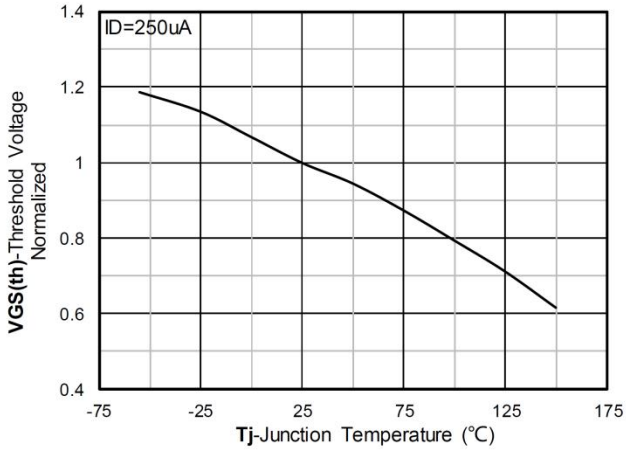
RDS(on) VS Drain Current



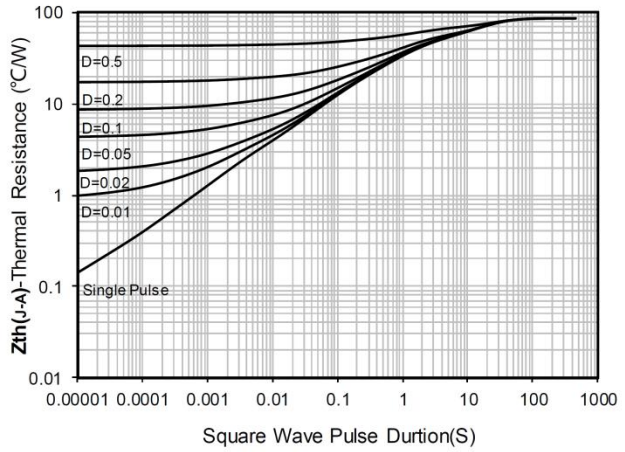
Forward characteristics of reverse diode



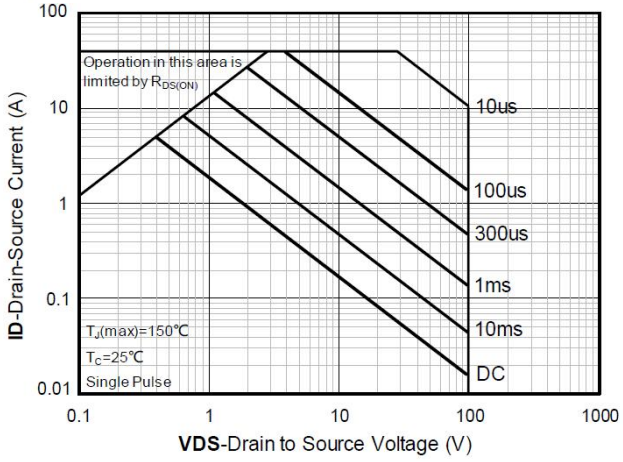
Normalized breakdown voltage



Normalized Threshold voltage

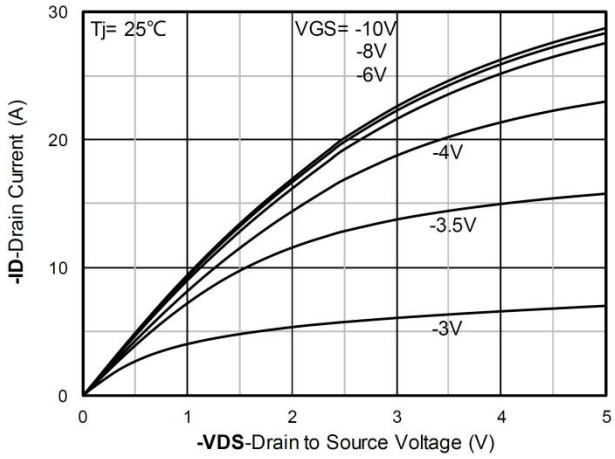


Maximum Transient Thermal Impedance

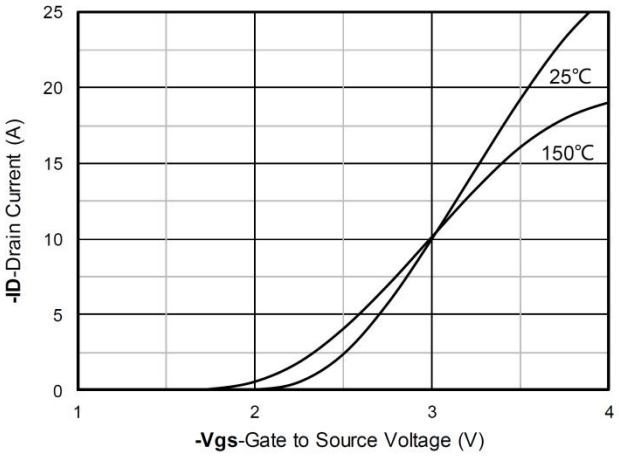


Safe Operation Area

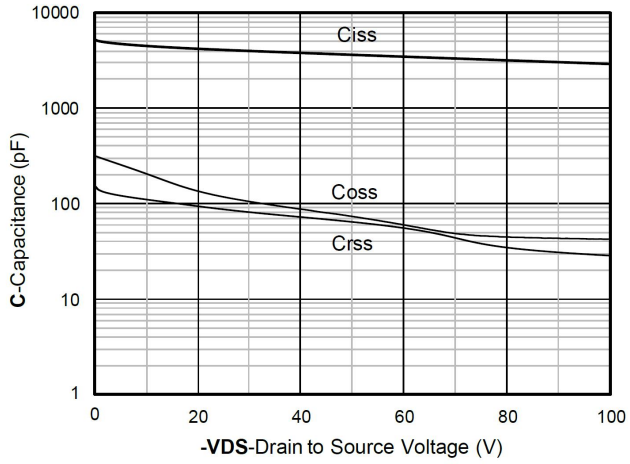
P-Channel Typical Characteristic



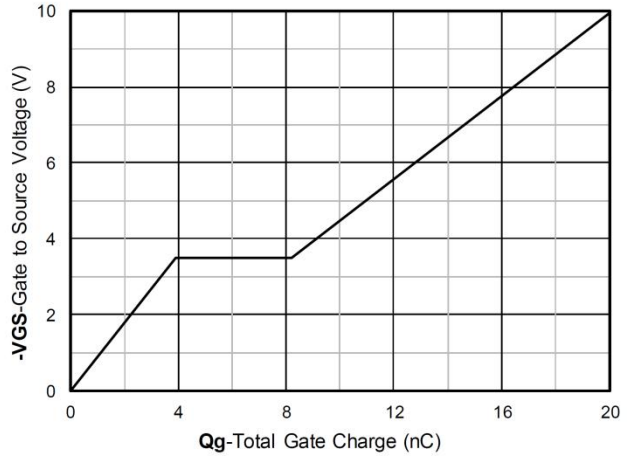
Output Characteristics



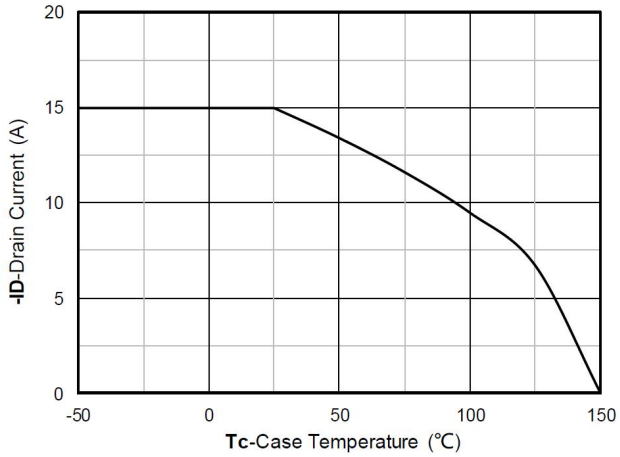
Transfer Characteristics



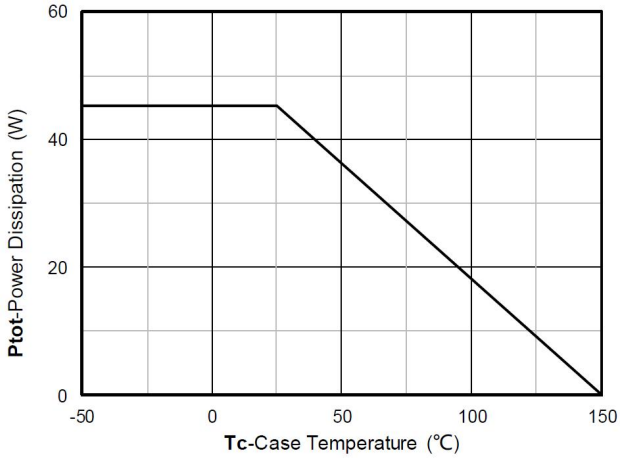
Capacitance Characteristics



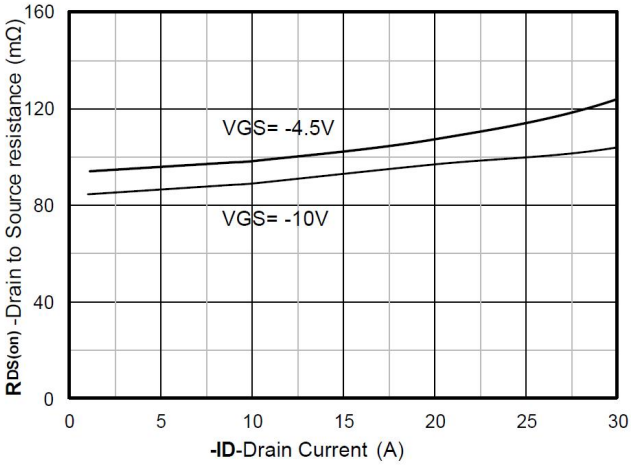
Gate Charge



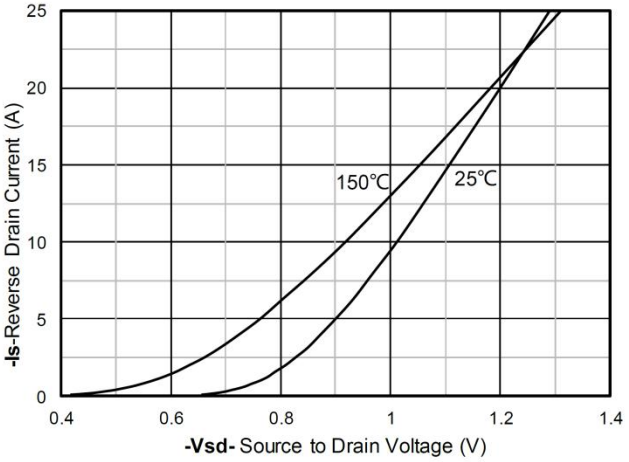
Current dissipation



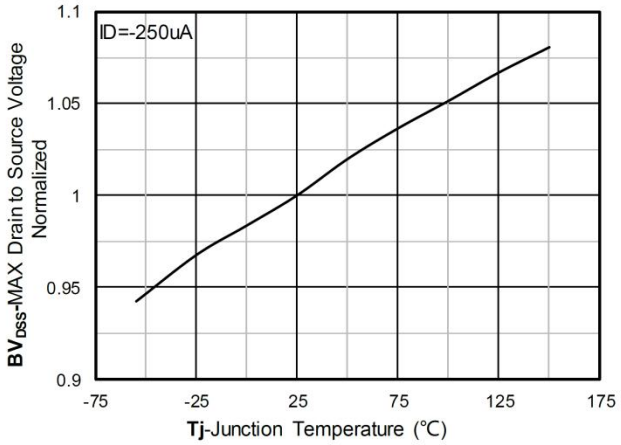
Power dissipation



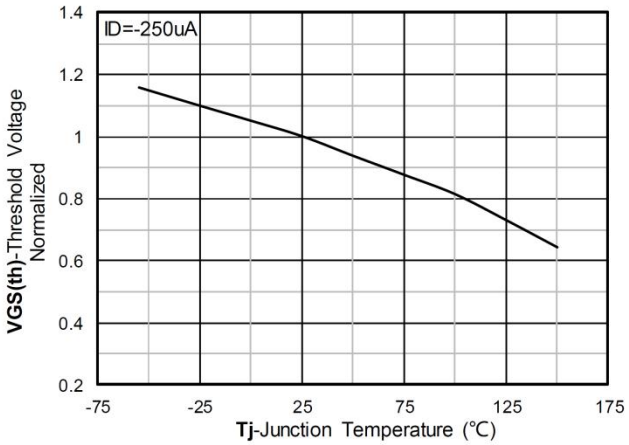
RDS(on) VS Drain Current



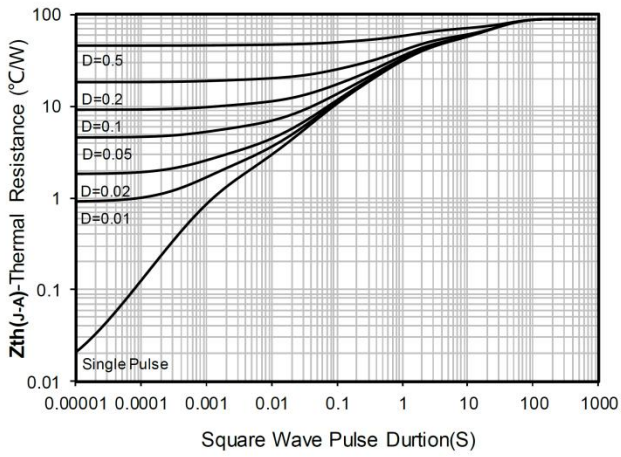
Forward characteristics of reverse diode



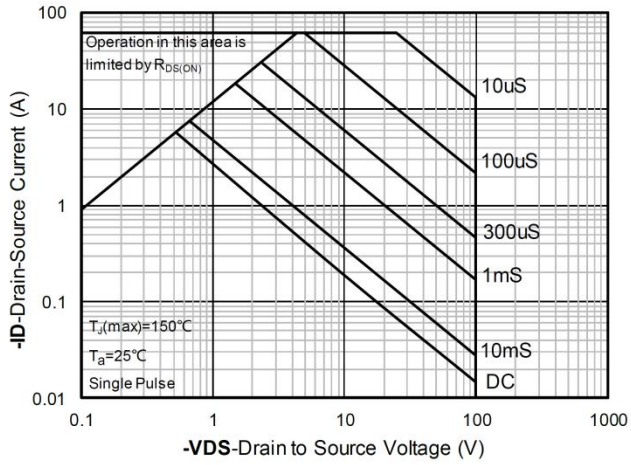
Normalized breakdown voltage



Normalized Threshold voltage

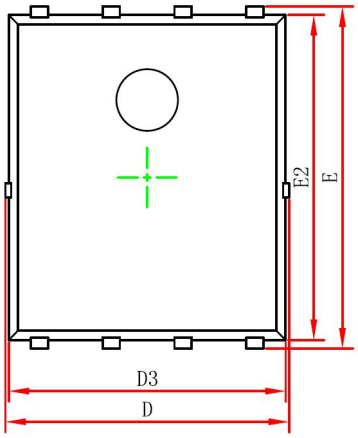


Maximum Transient Thermal Impedance

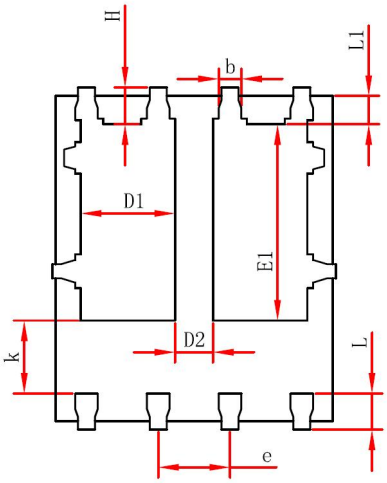


Safe Operation Area

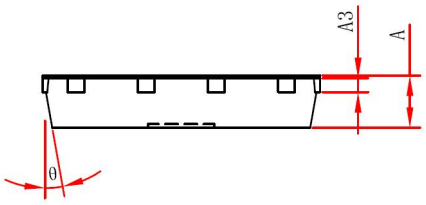
PDFN5X6-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254 REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	1.470	1.870	0.058	0.074
D2	0.470	0.870	0.019	0.034
E1	3.375	3.575	0.133	0.141
D3	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°